IGBT - Field Stop 600 V, 60 A

FGH60N60SF

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.3 \text{ V (Typ.)}$ @ $I_C = 60 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

Applications

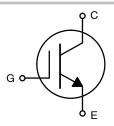
• Solar Inverter, UPS, Welder, PFC

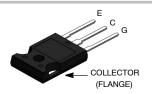


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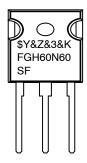
V _{CES}	Ic
600 V	60 A





TO-247-3LD CASE 340CK

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code

&3 = Numeric Date Code &K = Lot Code

FGH60N60SF = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V _{GES}	Gate to Emitter Voltage	Gate to Emitter Voltage		V
	Transient Gate-to-Emitter Voltage		±30	V
Ic	Collector Current T _C	T _C = 25°C		Α
	T _C	= 100°C	60	Α
I _{CM} (Note 1)	Pulsed Collector Current T _C	= 25°C	180	Α
P _D	Maximum Power Dissipation T _C	= 25°C	378	W
	T _C	= 100°C	151	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{STG}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive test: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Max.	Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction to Case	-	0.33	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH60N60SFTU	FGH60N60SF	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit		
OFF CHARACT	OFF CHARACTERISTICS							
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	600	-	-	V		
$\Delta BV_{CES}/\Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	-	0.4	_	V/°C		
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}$, $V_{GE} = 0 V$	-	-	250	μΑ		
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}$, $V_{CE} = 0 V$	-	-	±400	nA		
ON CHARACTE	ON CHARACTERISTICS							
V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \mu A, V_{CE} = V_{GE}$	4.0	5.0	6.5	V		
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 60 A, V _{GE} = 15 V,	-	2.3	2.9	V		
		$I_C = 60 \text{ A}, V_{GE} = 15 \text{ V},$ $T_C = 125^{\circ}\text{C}$	_	2.5	_	٧		
DYNAMIC CHA	DYNAMIC CHARACTERISTICS							
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	2820	_	pF		
C _{oes}	Output Capacitance	1 - 1 1011 12	-	350	-	pF		
C _{res}	Reverse Transfer Capacitance		-	140	-	pF		

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VITCHING C	CHARACTERISTICS		•	•		
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 60 \text{ A},$	-	22	_	ns
T _r	Rise Time	R_G = 5 Ω, V_{GE} = 15 V, Inductive Load, T_C = 25°C	-	42	-	ns
T _{d(off)}	Turn-Off Delay Time		-	134	_	ns
T _f	Fall Time		-	31	62	ns
E _{on}	Turn-On Switching Loss		-	1.79	_	mJ
E _{off}	Turn-Off Switching Loss		-	0.67	-	mJ
E _{ts}	Total Switching Loss		-	2.46	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 60 \text{ A},$	-	22	-	ns
T _r	Rise Time	$R_G = 5 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125$ °C	-	44	-	ns
T _{d(off)}	Turn-Off Delay Time		-	144	-	ns
T _f	Fall Time		-	43	-	ns
E _{on}	Turn-On Switching Loss		-	1.88	=	mJ
E _{off}	Turn-Off Switching Loss		-	1.0	=	mJ
E _{ts}	Total Switching Loss		-	2.88	=	mJ
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 60 A, V _{GF} = 15 V	-	198	-	nC
Q _{ge}	Gate to Emitter Charge	VGE = 15 V	-	22	_	nC
Q _{gc}	Gate to Collector Charge		_	106	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

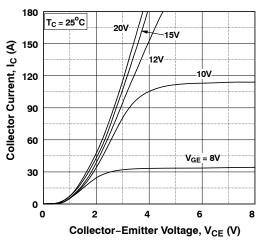


Figure 1. Typical Output Characteristics

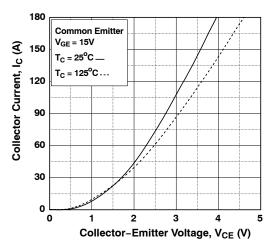
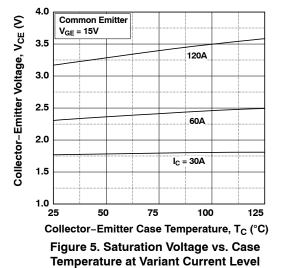


Figure 3. Typical Saturation Voltage Characteristics



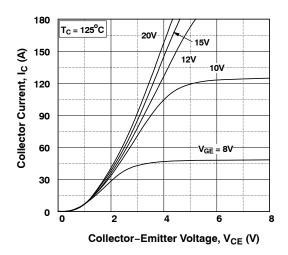


Figure 2. Typical Output Characteristics

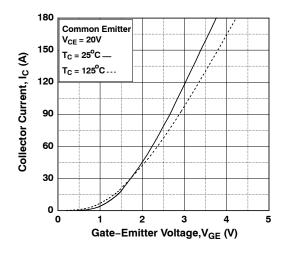


Figure 4. Transfer Characteristics

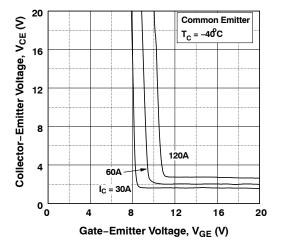


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

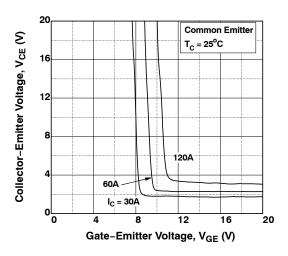


Figure 7. Saturation Voltage vs. V_{GE}

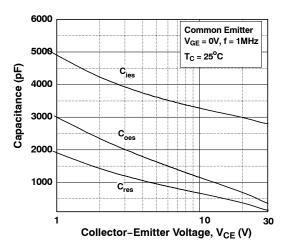


Figure 9. Capacitance Characteristics

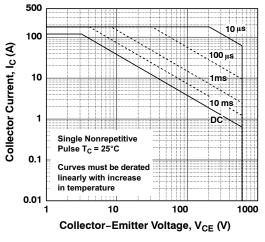


Figure 11. SOA Characteristics

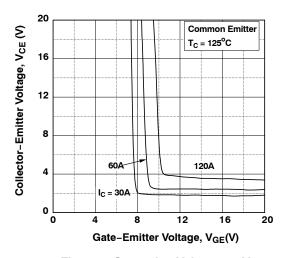


Figure 8. Saturation Voltage vs. V_{GE}

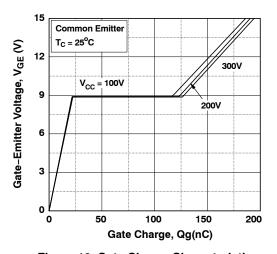


Figure 10. Gate Charge Characteristics

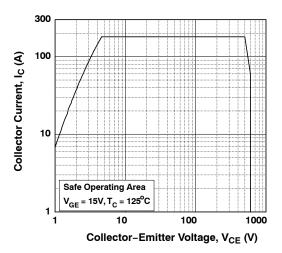


Figure 12. Turn-off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

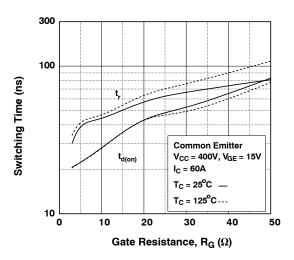


Figure 13. Turn-on Characteristics vs. Gate Resistance

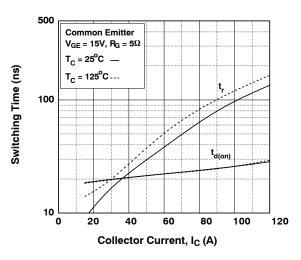


Figure 15. Turn-on Characteristics vs. Collector Current

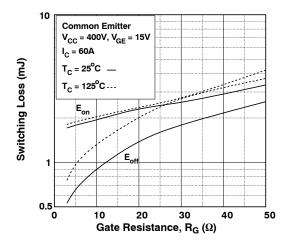


Figure 17. Switching Loss vs. Gate Resistance

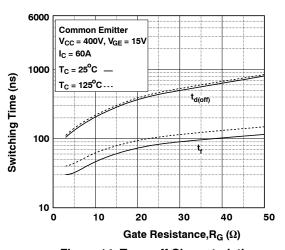


Figure 14. Turn-off Characteristics vs. Gate Resistance

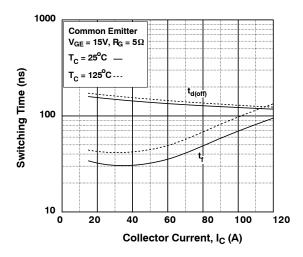


Figure 16. Turn-off Characteristics vs. Collector Current

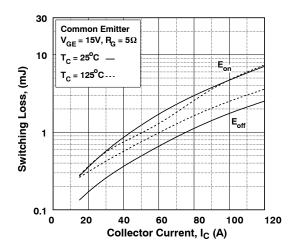


Figure 18. Switching Loss vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

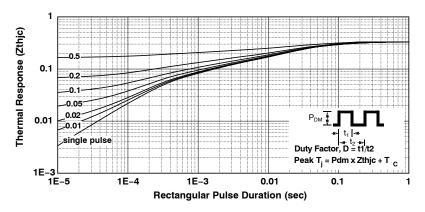
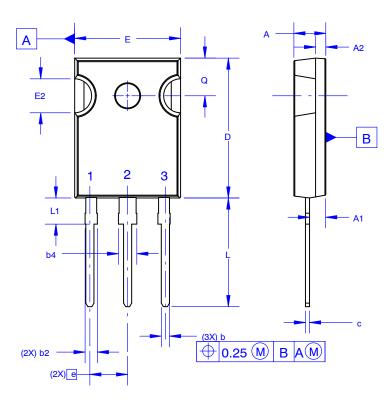


Figure 19. Transient Thermal Impedance of IGBT

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

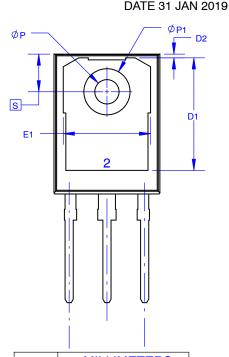
A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS			
DIIVI	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A 1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D	20.32	20.57	20.82	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E	15.37	15.62	15.87	
E1	12.81	?	~	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	15.75	16.00	16.25	
L1	3.69	3.81	3.93	
ØΡ	3.51	3.58	3.65	
ØP1	6.60	6.80	7.00	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	

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DESCRIPTION:	TO-247-3LD SHORT LEAD		PAGE 1 OF 1	

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